NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Datasheet

### **AEC-Q101 Qualified**

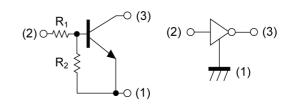
| Parameter            | Value |
|----------------------|-------|
| V <sub>CC</sub>      | 50V   |
| I <sub>C(MAX.)</sub> | 100mA |
| R <sub>1</sub>       | 2.2kΩ |
| $R_2$                | 10kΩ  |

# ● Outline SOT-323 SC-70 (2) (UMT3)

#### Features

- 1) Built-In Biasing Resistors,  $R_1 = 2.2k\Omega$ ,  $R_2 = 10k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA123YUA FRA

#### •Inner circuit



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Application

INVERTER, INTERFACE, DRIVER

## Packaging specifications

| Part No.      | Package           | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width (mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
|---------------|-------------------|-----------------|----------------|-------------------|-----------------|---------------------------------|---------|
| DTC123YUA FRA | SOT-323<br>(UMT3) | 2021            | T106           | 180               | 8               | 3000                            | 62      |

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

| Parameter                    | Symbol                 | Values      | Unit |
|------------------------------|------------------------|-------------|------|
| Supply voltage               | V <sub>CC</sub>        | 50          | V    |
| Input voltage                | V <sub>IN</sub>        | -5 to 12    | V    |
| Output current               | Io                     | 100         | mA   |
| Collector current            | I <sub>C(MAX)</sub> *1 | 100         | mA   |
| Power dissipation            | P <sub>D</sub> *2      | 200         | mW   |
| Junction temperature         | T <sub>j</sub>         | 150         | °C   |
| Range of storage temperature | T <sub>stg</sub>       | -55 to +150 | °C   |

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

| Davanatav  | Currente ed                    | Conditions  | Values |      |      | 1.114 |  |
|--|--------------------------------|---|--------|------|------|-------|--|
| Parameter  | Symbol Conditions -            |   | Min.   | Тур. | Max. | Unit  |  |
| Input voltage  | $V_{I(off)}$                   | V <sub>CC</sub> = 5V, I <sub>O</sub> = 100μA                | -      | -    | 0.3  | - v   |  |
| Input voltage  | V <sub>I(on)</sub>             | $V_O = 0.3V$ , $I_O = 20mA$                                 | 3.0    | -    | -    |       |  |
| Output voltage                                       | V <sub>O(on)</sub>             | I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA               | 1      | 100  | 300  | mV    |  |
| Input current  | I <sub>I</sub>                 | V <sub>I</sub> = 5V   | 1      | -    | 3.8  | mA    |  |
| Output current $I_{O(off)}$ $V_{CC} = 50V, V_I = 0V$ |                                | $V_{CC} = 50V, V_{I} = 0V$                                  | 1      | -    | 500  | nA    |  |
| DC current gain                                      | G <sub>I</sub>                 | V <sub>O</sub> = 5V, I <sub>O</sub> = 10mA                  |        | -    | -    | -     |  |
| Input resistance                                     | R <sub>1</sub>                 | -   | 1.54   | 2.2  | 2.86 | kΩ    |  |
| Resistance ratio                                     | R <sub>2</sub> /R <sub>1</sub> | -   | 3.6    | 4.5  | 5.5  | -     |  |
| Transition frequency                                 | f <sub>T</sub> *1              | V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA,<br>f = 100MHz | -      | 250  | -    | MHz   |  |

<sup>\*1</sup> Characteristics of built-in transistor

<sup>\*2</sup> Each terminal mounted on a reference land.

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

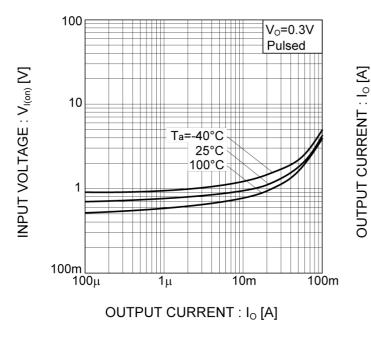


Fig.2 Output current vs. input voltage (OFF characteristics)

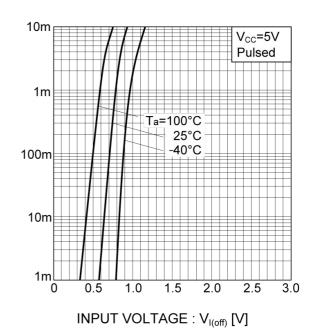


Fig.3 Output current vs. output voltage

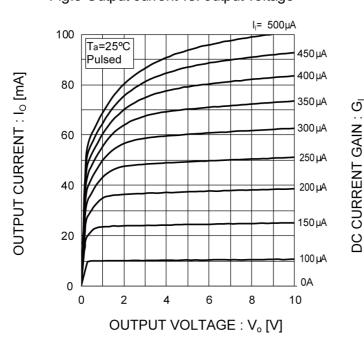
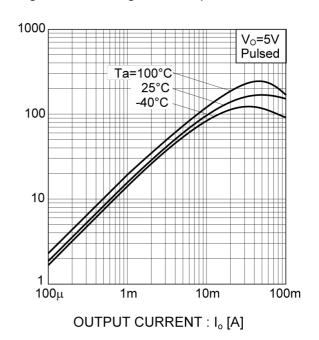


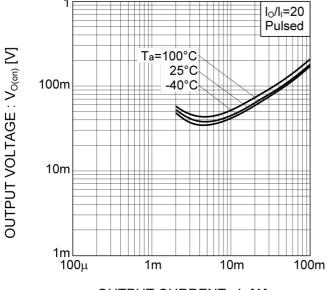
Fig.4 DC current gain vs. output current



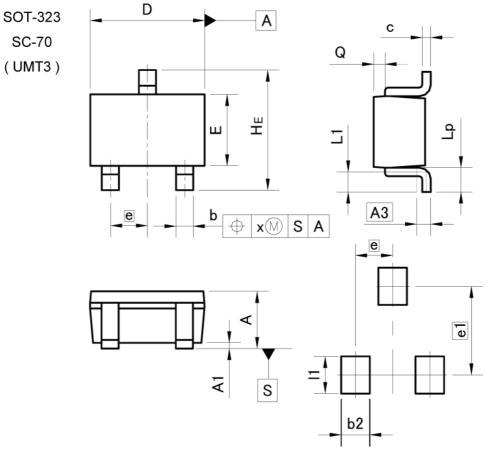
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# ●Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIM | MILIMETERS |       | HES   |  |
|-----|-------|------------|-------|-------|--|
| DIM | MIN   |            | MIN   | MAX   |  |
| Α   | 0.80  | 1.00       | 0.031 | 0.039 |  |
| A1  | 0.00  | 0.10       | 0.000 | 0.004 |  |
| A3  | 0.5   | 25         | 0.0   | 10    |  |
| b   | 0.25  | 0.40       | 0.010 | 0.016 |  |
| С   | 0.10  | 0.20       | 0.004 | 0.008 |  |
| D   | 1.90  | 2.10       | 0.075 | 0.083 |  |
| E   | 1.15  | 1.35       | 0.045 | 0.053 |  |
| е   | 0.65  |            | 0.026 |       |  |
| HE  | 2.00  | 2.20       | 0.079 | 0.087 |  |
| L1  | 0.10  | 0.40       | 0.004 | 0.016 |  |
| Lp  | 0.25  | 0.55       | 0.010 | 0.022 |  |
| Q   | 0.10  | 0.30       | 0.004 | 0.012 |  |
| х   | _     | 0.10       | _     | 0.004 |  |

| DIM  | MILIMETERS |      | INCHES |       |  |
|------|------------|------|--------|-------|--|
| DIM  | MIN        | MAX  | MIN    | MAX   |  |
| b2   | _          | 0.50 | _      | 0.020 |  |
| e1   | 1.55       |      | 0.0    | 61    |  |
| - 11 | -          | 0.65 | -      | 0.026 |  |

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

| (110to 1) Modrodi Equipment Glacemodileri et trie Opecine / tppilodilerie |          |            |          |  |  |  |
|---|----------|------------|----------|--|--|--|
| JAPAN   | USA      | EU         | CHINA    |  |  |  |
| CLASSⅢ  | CLASSIII | CLASS II b | CLASSIII |  |  |  |
| CLASSIV   | CLASSIII | CLASSⅢ     | CLASSIII |  |  |  |

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  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
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For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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